Low-Voltage 1.8/2.5/3.3 V 16-Bit Transparent Latch With 3.6 V–Tolerant Inputs and Outputs (3–State, Non–Inverting)

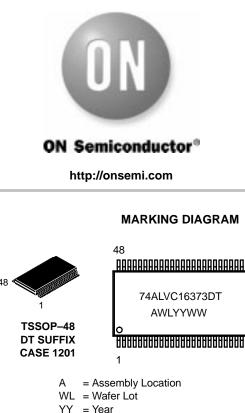
The 74ALVC16373 is an advanced performance, non-inverting 16-bit transparent latch. It is designed for very high-speed, very low-power operation in 1.8 V, 2.5 V or 3.3 V systems. The ALVC16373 is byte controlled, with each byte functioning identically, but independently. Each byte has separate Output Enable and Latch Enable inputs. These control pins can be tied together for full 16-bit operation.

The 74ALVC16373 contains 16 D-type latches with 3-state 3.6 V-tolerant outputs. When the Latch Enable (LEn) inputs are HIGH, data on the Dn inputs enters the latches. In this condition, the latches are transparent, (a latch output will change state each time its D input changes). When LE is LOW, the latch stores the information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE. The 3-state outputs are controlled by the Output Enable (\overline{OEn}) inputs. When \overline{OE} is LOW, the outputs are enabled. When \overline{OE} is HIGH, the standard outputs are in the high impedance state, but this does not interfere with new data entering into the latches.

- Designed for Low Voltage Operation: $V_{CC} = 1.65 3.6 \text{ V}$
- 3.6V Tolerant Inputs and Outputs
- High Speed Operation: 3.6 ns max for 3.0 to 3.6 V

4.5 ns max for 2.3 to 2.7 V

- 6.8 ns max for 1.65 to 1.95 V
- Static Drive: ±24 mA Drive at 3.0 V ±12 mA Drive at 2.3 V ±4 mA Drive at 1.65 V
- Supports Live Insertion and Withdrawal
- I_{OFF} Specification Guarantees High Impedance When $V_{CC} = 0 V^{\dagger}$
- Near Zero Static Supply Current in All Three Logic States (40 μA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds ±250 mA @ 125°C
- ESD Performance: Human Body Model >2000 V; Machine Model >200 V
- Second Source to Industry Standard 74ALVC16373
- ⁺To ensure the outputs activate in the 3–state condition, the output enable pins should be connected to V_{CC} through a pull–up resistor. The value of the resistor is determined by the current sinking capability of the output connected to the $\overline{\text{OE}}$ pin.



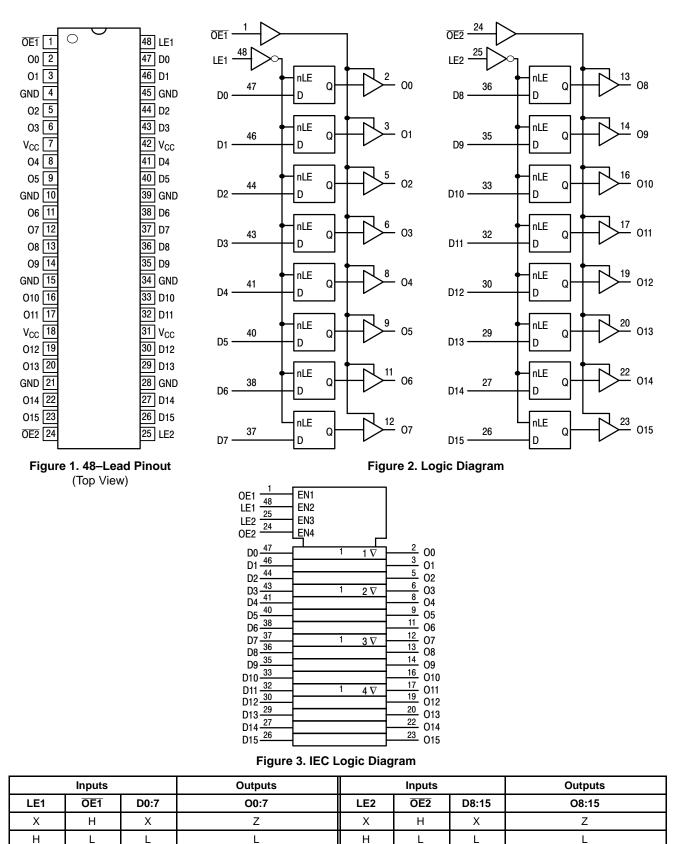
WW = Work Week

PIN NAMES

Pins	Function
<u>OEn</u>	Output Enable Inputs
LEn	Latch Enable Inputs
D0-D15	Inputs
00–015	Outputs

ORDERING INFORMATION

Device	Package	Shipping	
74ALVC16373DTR	TSSOP	2500/Tape & Reel	



http://onsemi.com 2

H = High Voltage Level; L = Low Voltage Level; Z = High Impedance State; X = High or Low Voltage Level and Transitions Are Acceptable, for

Н

L

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I_{CC} reasons, DO NOT FLOAT Inputs. O0 = No Change.

MAXIMUM RATINGS (Note 1)

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +4.6	V
VI	DC Input Voltage		-0.5 to $+4.6$	V
V _O	DC Output Voltage		-0.5 to $+4.6$	V
I _{IK}	DC Input Diode Current	V _I < GND	-50	mA
I _{OK}	DC Output Diode Current	V _O < GND	-50	mA
I _O	DC Output Sink/Source Current		±50	mA
I _{CC}	DC Supply Current per Supply Pin		±100	mA
I _{GND}	DC Ground Current per Ground Pin		±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seco	nds	260	°C
TJ	Junction Temperature Under Bias		+ 150	°C
θ_{JA}	Thermal Resistance (Note 2)		90	°C/W
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating	Oxygen Index: 30% – 35%	UL–94 V–0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage	Human Body Model (Note 3) Machine Model (Note 4) Charged Device Model (Note 5)	>2000 >200 N/A	V
I _{LATCH-UP}	Latch–Up Performance Above V _{CC}	and Below GND at 125°C (Note 6)	±250	mA

Maximum Ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum-rated conditions is not implied. Functional operation should be restricted to the Recommended Operating Conditions.

1. I_O absolute maximum rating must be observed.

2. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2-ounce copper trace with no air flow.

3. Tested to EIA/JESD22-A114-A.

4. Tested to EIA/JESD22-A115-A.

5. Tested to JESD22-C101-A.

6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Тур	Мах	Unit
V _{CC}	Supply Voltage	Operating Data Retention Only	1.65 1.2	3.3 3.3	3.6 3.6	V
VI	Input Voltage	(Note 7)	-0.5		3.6	V
Vo	Output Voltage	(Active State) (3–State)	0 0		V _{CC} 3.6	V
T _A	Operating Free–Air Temperature		-40		+85	°C
$\Delta t / \Delta V$	Input Transition Rise or Fall Rate, V_{IN} from 0.8 V to 2.	0 V, $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ $V_{CC} = 3.0 \text{ V} \pm 0.3 \text{ V}$	0 0		20 10	ns/V

7. Unused inputs may not be left open. All inputs must be tied to a high-logic voltage level or a low-logic input voltage level.

DC ELECTRICAL CHARACTERISTICS

			T _A = -40°0	C to +85°C	
Symbol	Characteristic	Condition	Min	Max	Unit
V _{IH}	HIGH Level Input Voltage (Note 8)	$1.65 \text{ V} \le \text{V}_{\text{CC}} < 2.3 \text{ V}$	0.65 x V _{CC}		V
		$2.3 \text{ V} \leq \text{V}_{CC} \leq 2.7 \text{ V}$	1.7		
		$2.7 \text{ V} < \text{V}_{\text{CC}} \le 3.6 \text{ V}$	2.0		
V _{IL}	LOW Level Input Voltage (Note 8)	$1.65 \text{ V} \le \text{V}_{\text{CC}} < 2.3 \text{ V}$		0.35 x V _{CC}	V
		$2.3~\text{V} \leq \text{V}_{CC} \leq 2.7~\text{V}$		0.7	
		$2.7 \text{ V} < \text{V}_{\text{CC}} \le 3.6 \text{ V}$		0.8	
V _{OH}	HIGH Level Output Voltage	$1.65 \text{ V} \le \text{V}_{CC} \le 3.6 \text{ V}; \text{ I}_{OH} = -100 \mu\text{A}$	V _{CC} - 0.2		V
		V _{CC} = 1.65 V; I _{OH} = -4 mA	1.2		
		V _{CC} = 2.3 V; I _{OH} = -6 mA	2.0		
		V _{CC} = 2.3 V; I _{OH} = -12 mA	1.7		
		$V_{CC} = 2.7 \text{ V}; I_{OH} = -12 \text{ mA}$	2.2		
		$V_{CC} = 3.0 \text{ V}; \text{ I}_{OH} = -12 \text{ mA}$	2.4		
		$V_{CC} = 3.0 \text{ V}; \text{ I}_{OH} = -24 \text{ mA}$	2.0		
V _{OL}	LOW Level Output Voltage	1.65 V \leq V_{CC} \leq 3.6 V; I_{OL} = 100 μA		0.2	V
		$V_{CC} = 1.65 \text{ V}; \text{ I}_{OL} = 4 \text{ mA}$		0.45	
		$V_{CC} = 2.3 \text{ V}; \text{ I}_{OL} = 6 \text{ mA}$		0.4	
		$V_{CC} = 2.3 \text{ V}; \text{ I}_{OL} = 12 \text{ mA}$		0.7	
		$V_{CC} = 2.7 \text{ V}; \text{ I}_{OL} = 12 \text{ mA}$		0.4	
		$V_{CC} = 3.0 \text{ V}; \text{ I}_{OL} = 24 \text{ mA}$		0.55	
l _l	Input Leakage Current	1.65 V \leq V_{CC} \leq 3.6 V; 0 V \leq V_I \leq 3.6 V		±5.0	μΑ
I _{OZ}	3–State Output Current	$1.65 \text{ V} \leq \text{V}_{CC} \leq 3.6 \text{ V}; \text{ 0 V} \leq \text{V}_{O} \leq 3.6 \text{ V};$ $\text{V}_{I} = \text{V}_{IH} \text{ or } \text{V}_{IL}$		±10	μΑ
I _{OFF}	Power–Off Leakage Current	$V_{CC} = 0 V; V_{I} \text{ or } V_{O} = 3.6 V$		10	μΑ
I _{CC}	Quiescent Supply Current (Note 9)	1.65 V \leq V_{CC} \leq 3.6 V; V_{I} = GND or V_{CC}		40	μΑ
		$1.65 \text{ V} \le \text{V}_{CC} \le 3.6 \text{ V}; \ 3.6 \text{ V} \le \text{V}_{I}, \ \text{V}_{O} \le 3.6 \text{ V}$		±40	μA
ΔI_{CC}	Increase in I _{CC} per Input	$2.7 \text{ V} < \text{V}_{\text{CC}} \le 3.6 \text{ V}; \text{ V}_{\text{IH}} = \text{V}_{\text{CC}} - 0.6 \text{ V}$		750	μA

8. These values of $V_{\rm I}$ are used to test DC electrical characteristics only. 9. Outputs disabled or 3–state only.

AC CHARACTERISTICS (Note 10; $t_R = t_F = 2.0 \text{ ns}$; $C_L = 30 \text{ pF}$; $R_L = 500 \Omega$)

					Lir	nits			
Symbol				T _A = −40°C to +85°C		C to +85°C			
			V _{CC} = 3. 0)V to 3.6 V	V _{CC} = 2.3	V to 2.7 V	V _{CC} = 1.65 to 1.95 V		
	Parameter	Waveform	Min	Max	Min	Max	Min	Max	Unit
t _{PLH} t _{PHL}	Propagation Delay Dn to On	1	1.1 1.1	3.6 3.6	1.0 1.0	4.5 4.5	1.5 1.5	6.8 6.8	ns
t _{PLH} t _{PHL}	Propagation Delay LE to On	1	1.0 1.0	3.9 3.9	1.0 1.0	4.9 4.9	1.5 1.5	7.8 7.8	ns
t _{PZH} t _{PZL}	Output Enable Time to High and Low Level	2	1.0 1.0	4.7 4.7	1.0 1.0	6.0 6.0	1.5 1.5	9.2 9.2	ns
t _{PHZ} t _{PLZ}	Output Disable Time From High and Low Level	2	1.4 1.4	4.1 4.1	1.2 1.2	5.1 5.1	1.5 1.5	6.8 6.8	ns
t _s	Setup Time, High or Low Dn to LE	3	1.1		1.0		2.5		ns
t _h	Hold Time, High or Low Dn to LE	3	1.4		1.5		1.0		ns
tw	LE Pulse Width, High	3	3.3		3.3		4.0		ns
t _{OSHL} t _{OSLH}	Output-to-Output Skew (Note 11)			0.5 0.5		0.5 0.5		0.75 0.75	ns

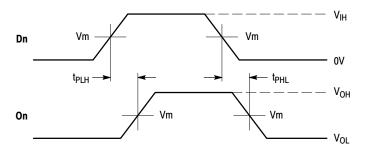
10. For $C_L = 50$ pF, add approximately 300 ps to the AC maximum specification.

11. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

CAPACITIVE CHARACTERISTICS

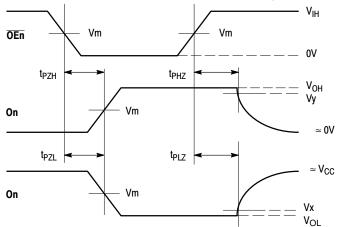
Symbol	Parameter	Parameter Condition		Unit
C _{IN}	Input Capacitance	Note 12	6	pF
C _{OUT}	Output Capacitance	Note 12	7	pF
C _{PD}	Power Dissipation Capacitance	Note 12, 10 MHz	20	pF

12. V_{CC} = 1.8, 2.5 or 3.3 V; V_{I} = 0 V or $V_{CC}.$



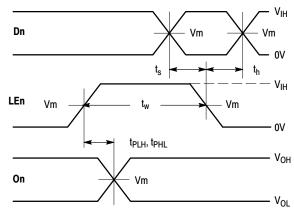
WAVEFORM 1 – PROPAGATION DELAYS $t_{R} = t_{F} = 2.0ns, 10\% to 90\%; f = 1MHz; t_{W} = 500ns$

Figure 4. AC Waveforms



WAVEFORM 2 - OUTPUT ENABLE AND DISABLE TIMES

t_R = t_F = 2.0ns, 10% to 90%; f = 1MHz; t_W = 500ns

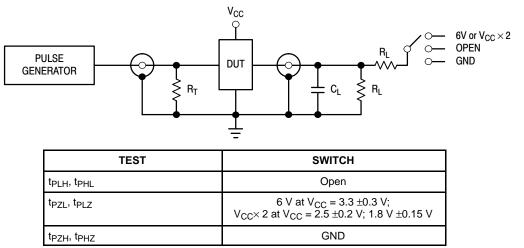


WAVEFORM 3 – LE to On PROPAGATION DELAYS, LE MINIMUM PULSE WIDTH, Dn to LE SETUP AND HOLD TIMES

 t_{R} = t_{F} = 2.0ns, 10% to 90%; f = 1MHz; t_{W} = 500ns except when noted

	V _{cc}				
Symbol	3.3V ±0.3V	2.5V ±0.2V	1.8V ±0.15V		
V _{IH}	2.7V	V _{CC}	V _{CC}		
V _m	1.5V	V _{CC} /2	V _{CC} /2		
V _x	V _{OL} + 0.3V	V _{OL} + 0.15V	V _{OL} + 0.15V		
Vy	V _{OH} – 0.3V	V _{OH} – 0.15V	V _{OH} – 0.15V		

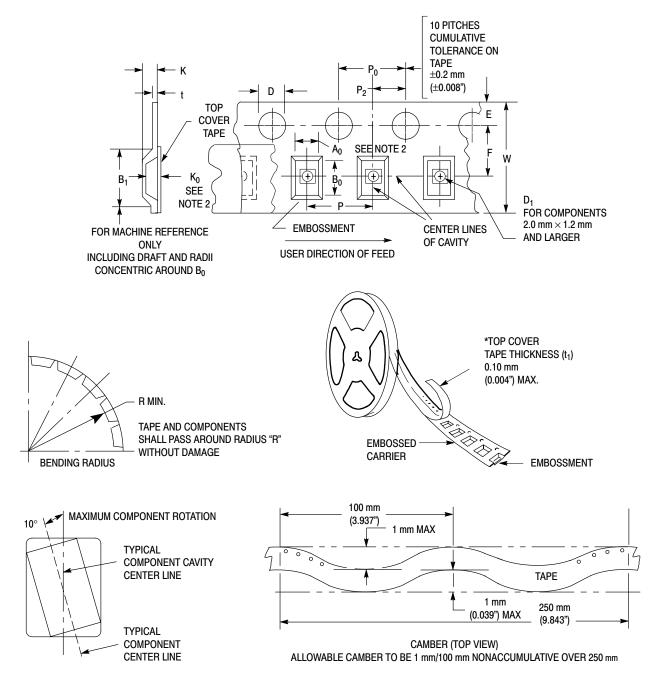
Figure 5. AC Waveforms



 C_L = 30 pF or equivalent (Includes jig and probe capacitance) R_L = 500 Ω or equivalent

 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω)

Figure 6. Test Circuit





Tape Size	B ₁ Max	D	D ₁	E	F	к	Р	P ₀	P ₂	R	т	w
24mm	20.1mm (0.791")	1.5 + 0.1mm -0.0 (0.059 +0.004" -0.0)	1.5mm Min (0.060")	1.75 ±0.1 mm (0.069 ±0.004")	11.5 ±0.10 mm (0.453 ±0.004")	11.9 mm Max (0.468")	16.0 ±0.1 mm (0.63 ±0.004")	4.0 ±0.1 mm (0.157 ±0.004")	2.0 ±0.1 mm (0.079 ±0.004")	30 mm (1.18")	0.6 mm (0.024")	24.3 mm (0.957")

EMBOSSED CARRIER DIMENSIONS	(See Notes 1 and 2)	١
		1

1. Metric Dimensions Govern-English are in parentheses for reference only.

 A₀, B₀, and K₀ are determined by component size. The clearance between the components and the cavity must be within 0.05 mm min to 0.50 mm max. The component cannot rotate more than 10° within the determined cavity.

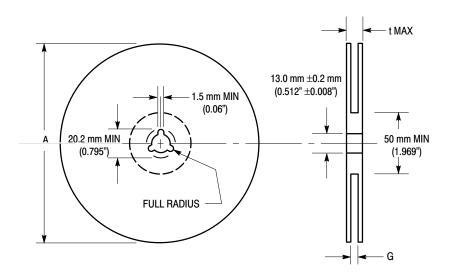
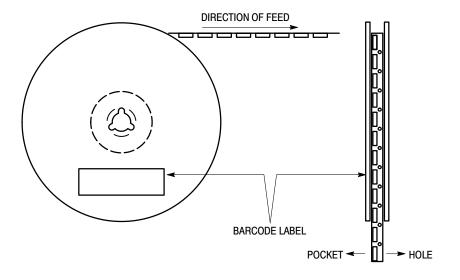


Figure 8. Reel Dimensions

REEL DIMENSIONS

Tape Size	A Max	G	t Max
24 mm	360 mm	24.4 mm + 2.0 mm, -0.0	30.4 mm
	(14.173")	(0.961" + 0.078", -0.00)	(1.197")





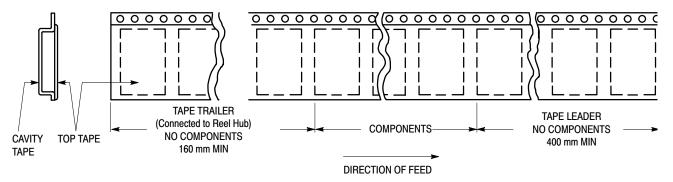
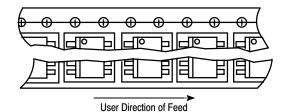


Figure 10. Tape Ends for Finished Goods





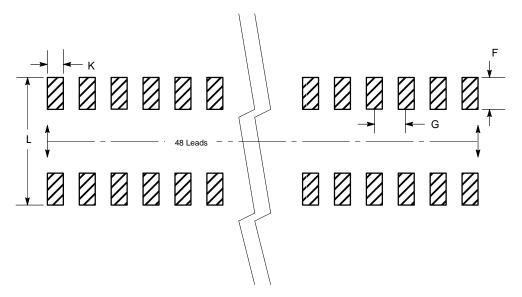


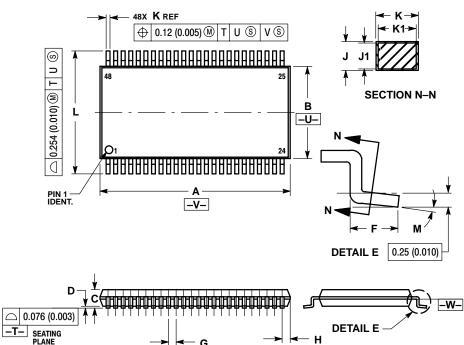
Figure 12. Package Footprint

PACKAGE DIMENSIONS

TSSOP DT SUFFIX CASE 1201-01 **ISSUE A**

- н

> -



- G

- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR
 PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 TERMINAL NUMBERS ARE SHOWN FOR
- MATERIAL CONDITION.
 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	12.40	12.60	0.488	0.496	
В	6.00	6.20	0.236	0.244	
C		1.10		0.043	
D	0.05	0.15	0.002	0.006	
F	0.50	0.75	0.020	0.030	
G	0.50	BSC	0.0197 BSC		
H	0.37		0.015		
J	0.09	0.20	0.004	0.008	
J1	0.09	0.16	0.004	0.006	
K	0.17	0.27	0.007	0.011	
K1	0.17	0.23	0.007	0.009	
L	7.95	8.25	0.313	0.325	
Μ	0 °	8 °	0 °	8 °	

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